

## 1. General description

AC Thyristor Triac power switch in a SOT78 (TO-220AB) plastic package with selfprotective clamping capabilities against low and high energy transients. This "series CTN" triac will commute the full RMS current at the maximum rated junction temperature ( $T_{j(max)} = 150\text{ °C}$ ) without the aid of a snubber. It is used in applications where "high junction operating temperature capability" is required.

## 2. Features and benefits

- Clamping structure ensuring safe high over-voltage withstand capability
- High junction operating temperature capability ( $T_{j(max)} = 150\text{ °C}$ )
- High minimum IGT for guaranteed immunity to gate noise
- Full cycle AC conduction
- Over-voltage withstand capability to IEC 61000-4-5
- Pin compatible with standard triacs
- Protective self turn-on capability for high energy transients
- Safe clamping capability for low energy over-voltage transients
- Less sensitive gate for high noise immunity
- Triggering in three quadrants only
- Planar passivated for voltage ruggedness and reliability
- High commutation capability with maximum false trigger immunity
- Very high immunity to false turn-on by  $dV/dt$  and IEC 61000-4-4 fast transient
- Package is RoHS compliant
- Package meets UL94V0 flammability requirement

## 3. Applications

- Electronic thermostats (heating and cooling)
- High power motor controls e.g washing machine and vacuum cleaners
- Rectifier-fed DC inductive loads e.g DC motors and solenoids
- Refrigeration and air conditioning compressors
- Applications subject to high temperature ( $T_{j(max)} = 150\text{ °C}$ )

## 4. Quick reference data

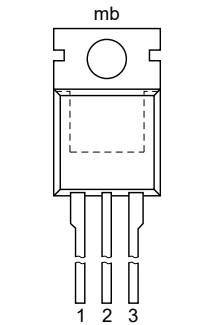
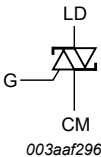
Table 1. Quick reference data

| Symbol       | Parameter                         | Conditions   | Min | Typ | Max | Unit |
|--------------|-----------------------------------|--|-----|-----|-----|------|
| $V_{DRM}$    | repetitive peak off-state voltage |  | -   | -   | 800 | V    |
| $I_{T(RMS)}$ | RMS on-state current              | full sine wave; $T_{mb} \leq 126\text{ °C}$ ; <a href="#">Fig. 1</a> ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a> | -   | -   | 10  | A    |

| Symbol                         | Parameter                             | Conditions   |  | Min  | Typ | Max | Unit               |
|--------------------------------|---------------------------------------|--|--|------|-----|-----|--------------------|
| $I_{TSM}$                      | non-repetitive peak on-state current  | full sine wave; $T_{j(init)} = 25\text{ }^{\circ}\text{C}$ ; $t_p = 20\text{ ms}$ ; <a href="#">Fig. 4</a> ; <a href="#">Fig. 5</a>  |  | -    | -   | 90  | A                  |
|                                |                                       | full sine wave; $T_{j(init)} = 25\text{ }^{\circ}\text{C}$ ; $t_p = 16.7\text{ ms}$  |  | -    | -   | 99  | A                  |
| $T_j$                          | junction temperature                  |  |  | -    | -   | 150 | $^{\circ}\text{C}$ |
| $V_{PP}$                       | peak pulse voltage                    | $T_j = 25\text{ }^{\circ}\text{C}$ ; non-repetitive, off-state; <a href="#">Fig. 6</a>   |  | -    | -   | 2   | kV                 |
| <b>Static characteristics</b>  |                                       |  |  |      |     |     |                    |
| $I_{GT}$                       | gate trigger current                  | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; LD+ G+; $T_j = 25\text{ }^{\circ}\text{C}$ ; <a href="#">Fig. 8</a>  |  | 5    | -   | 35  | mA                 |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; LD+ G-; $T_j = 25\text{ }^{\circ}\text{C}$ ; <a href="#">Fig. 8</a>  |  | 5    | -   | 35  | mA                 |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; LD- G-; $T_j = 25\text{ }^{\circ}\text{C}$ ; <a href="#">Fig. 8</a>  |  | 5    | -   | 35  | mA                 |
| $I_H$                          | holding current                       | $V_D = 12\text{ V}$ ; $T_j = 25\text{ }^{\circ}\text{C}$ ; <a href="#">Fig. 10</a>   |  | -    | -   | 30  | mA                 |
| $V_T$                          | on-state voltage                      | $I_T = 14\text{ A}$ ; $T_j = 25\text{ }^{\circ}\text{C}$ ; <a href="#">Fig. 11</a>   |  | -    | -   | 1.5 | V                  |
| $V_{CL}$                       | clamping voltage                      | $I_{CL} = 0.1\text{ mA}$ ; $t_p = 1\text{ ms}$ ; $T_j = 25\text{ }^{\circ}\text{C}$  |  | 850  | -   | -   | V                  |
| <b>Dynamic characteristics</b> |                                       |  |  |      |     |     |                    |
| $dV_D/dt$                      | rate of rise of off-state voltage     | $V_{DM} = 536\text{ V}$ ; $T_j = 125\text{ }^{\circ}\text{C}$ ; ( $V_{DM} = 67\%$ of $V_{DRM}$ ); exponential waveform; gate open circuit                                    |  | 4000 | -   | -   | V/ $\mu\text{s}$   |
|                                |                                       | $V_{DM} = 536\text{ V}$ ; $T_j = 150\text{ }^{\circ}\text{C}$ ; exponential waveform; gate open circuit  |  | 2000 | -   | -   | V/ $\mu\text{s}$   |
| $dI_{com}/dt$                  | rate of change of commutating current | $V_D = 400\text{ V}$ ; $T_j = 150\text{ }^{\circ}\text{C}$ ; $I_{T(RMS)} = 10\text{ A}$ ; $dV_{com}/dt = 20\text{ V}/\mu\text{s}$ ; gate open circuit; snubberless condition |  | 5    | -   | -   | A/ms               |
|                                |                                       | $V_D = 400\text{ V}$ ; $T_j = 150\text{ }^{\circ}\text{C}$ ; $I_{T(RMS)} = 10\text{ A}$ ; $dV_{com}/dt = 10\text{ V}/\mu\text{s}$ ; gate open circuit                        |  | 10   | -   | -   | A/ms               |
|                                |                                       | $V_D = 400\text{ V}$ ; $T_j = 150\text{ }^{\circ}\text{C}$ ; $I_{T(RMS)} = 10\text{ A}$ ; $dV_{com}/dt = 1\text{ V}/\mu\text{s}$ ; gate open circuit                         |  | 15   | -   | -   | A/ms               |

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description         | Simplified outline  | Graphic symbol   |
|-----|--------|---------------------|---|--|
| 1   | CM     | common              |  <p>TO-220AB (SOT78)</p> |  <p>LD<br/>G<br/>CM<br/>003aaf296</p> |
| 2   | LD     | load                |   |  |
| 3   | G      | gate                |   |  |
| mb  | LD     | mounting base; load |   |  |

6. Ordering information

Table 3. Ordering information

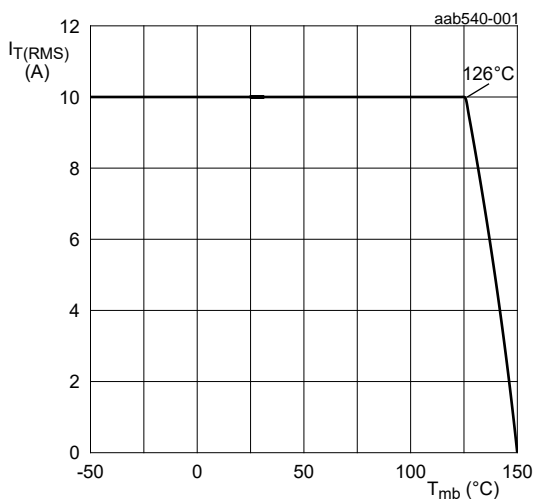
| Type number   | Package  |  |         |
|---------------|----------|--|---------|
|               | Name     | Description  | Version |
| ACTT10-800CTN | TO-220AB | plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB | SOT78   |

## 7. Limiting values

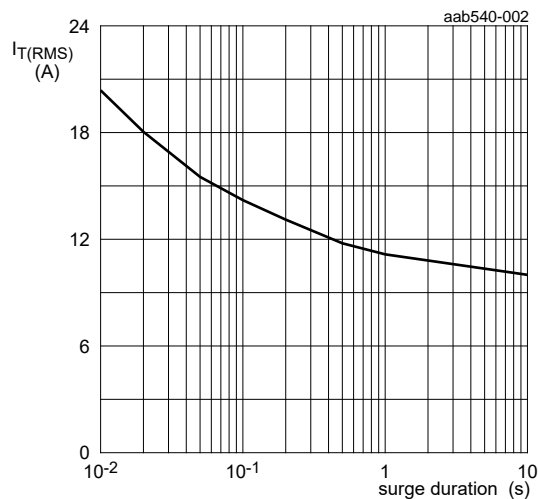
**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol              | Parameter                            | Conditions  | Min | Max | Unit                   |
|---------------------|--------------------------------------|---|-----|-----|------------------------|
| $V_{\text{DRM}}$    | repetitive peak off-state voltage    |   | -   | 800 | V                      |
| $I_{\text{T(RMS)}}$ | RMS on-state current                 | full sine wave; $T_{\text{mb}} \leq 126\text{ }^{\circ}\text{C}$ ; <a href="#">Fig. 1</a> ; <a href="#">Fig. 2</a> ; <a href="#">Fig. 3</a>         | -   | 10  | A                      |
| $I_{\text{TSM}}$    | non-repetitive peak on-state current | full sine wave; $T_{\text{j(init)}} = 25\text{ }^{\circ}\text{C}$ ; $t_{\text{p}} = 20\text{ ms}$ ; <a href="#">Fig. 4</a> ; <a href="#">Fig. 5</a> | -   | 90  | A                      |
|                     |                                      | full sine wave; $T_{\text{j(init)}} = 25\text{ }^{\circ}\text{C}$ ; $t_{\text{p}} = 16.7\text{ ms}$   | -   | 99  | A                      |
| $I^2t$              | $I^2t$ for fusing                    | $t_{\text{p}} = 10\text{ ms}$ ; sine-wave pulse   | -   | 40  | $\text{A}^2\text{s}$   |
| $di_{\text{T}}/dt$  | rate of rise of on-state current     | $I_{\text{G}} = 70\text{ mA}$   | -   | 100 | $\text{A}/\mu\text{s}$ |
| $I_{\text{GM}}$     | peak gate current                    | $t = 20\text{ }\mu\text{s}$   | -   | 2   | A                      |
| $P_{\text{GM}}$     | peak gate power                      |   | -   | 5   | W                      |
| $P_{\text{G(AV)}}$  | average gate power                   | over any 20 ms period   | -   | 0.5 | W                      |
| $T_{\text{stg}}$    | storage temperature                  |   | -40 | 150 | $^{\circ}\text{C}$     |
| $T_{\text{j}}$      | junction temperature                 |   | -   | 150 | $^{\circ}\text{C}$     |
| $V_{\text{PP}}$     | peak pulse voltage                   | $T_{\text{j}} = 25\text{ }^{\circ}\text{C}$ ; non-repetitive, off-state; <a href="#">Fig. 6</a>   | -   | 2   | kV                     |

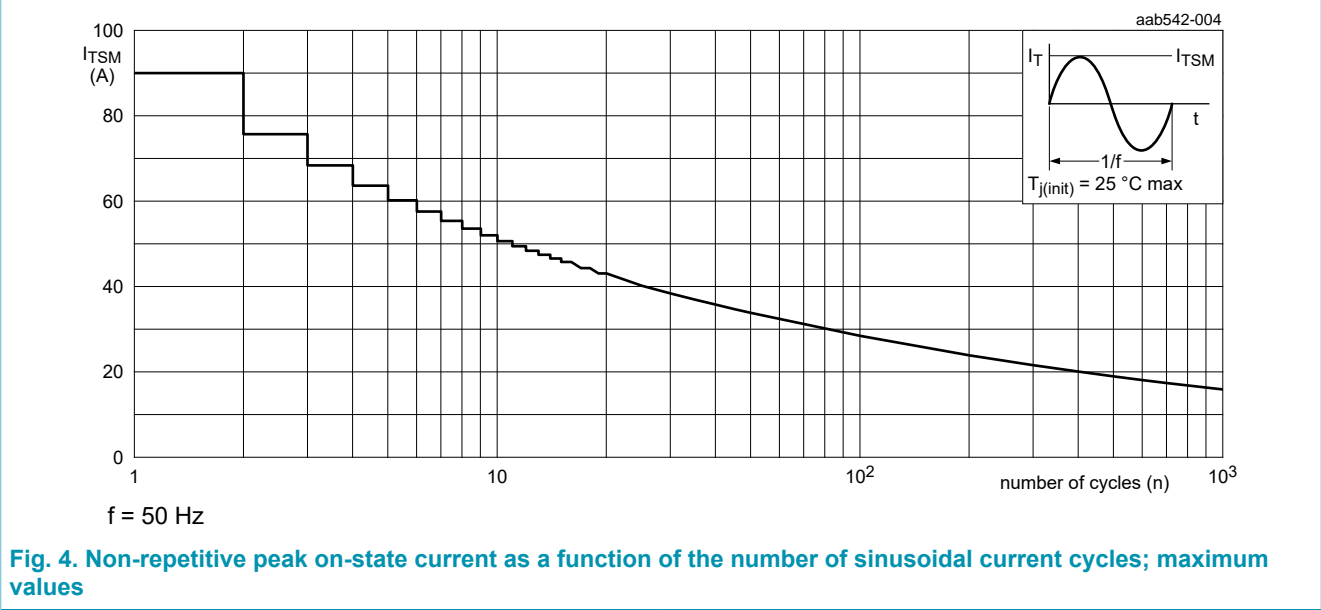
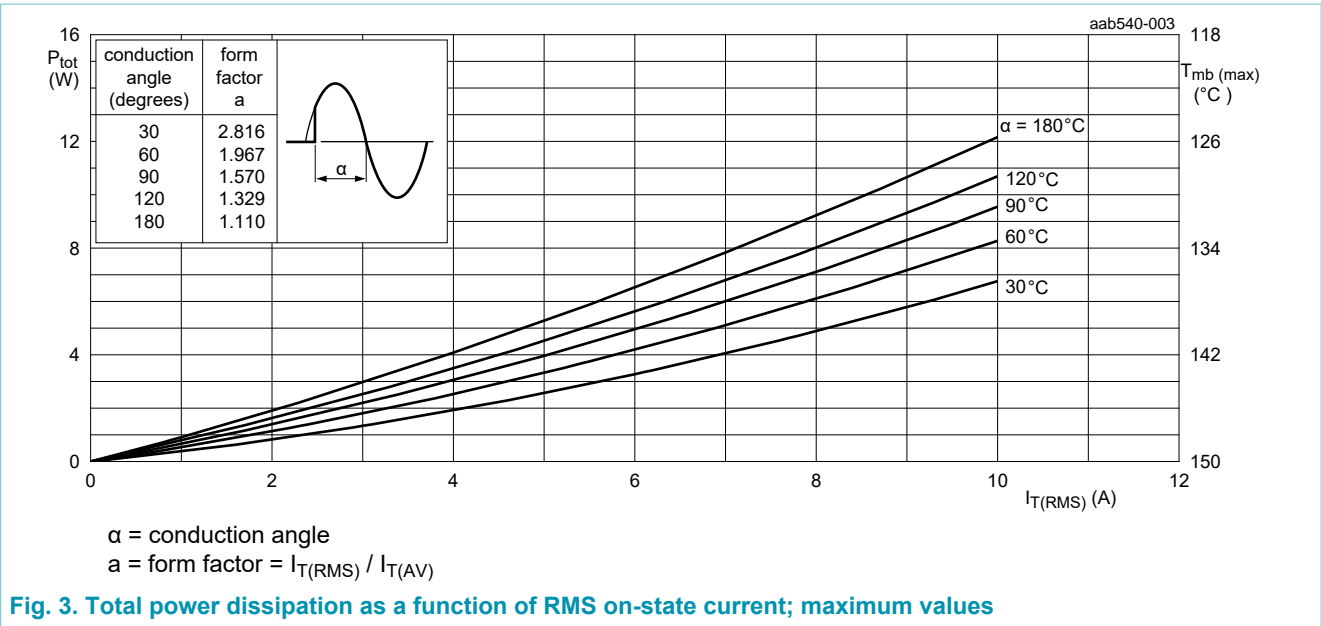


**Fig. 1. RMS on-state current as a function of mounting base temperature; maximum values**



$f = 50\text{ Hz}$ ;  $T_{\text{mb}} = 126\text{ }^{\circ}\text{C}$

**Fig. 2. RMS on-state current as a function of surge duration; maximum values**



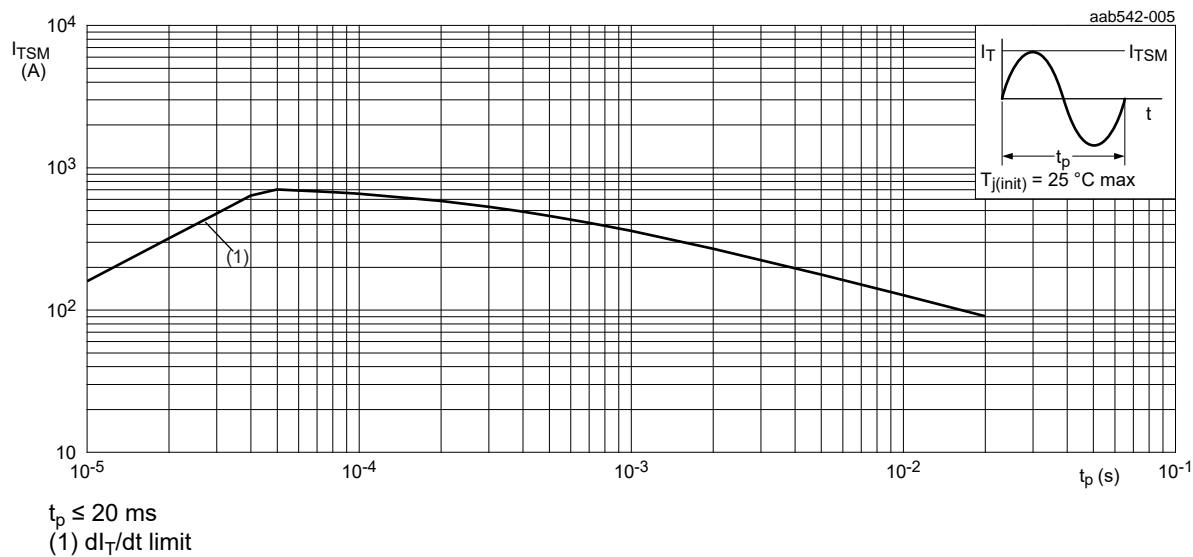


Fig. 5. Non-repetitive peak on-state current as a function of pulse width; maximum values

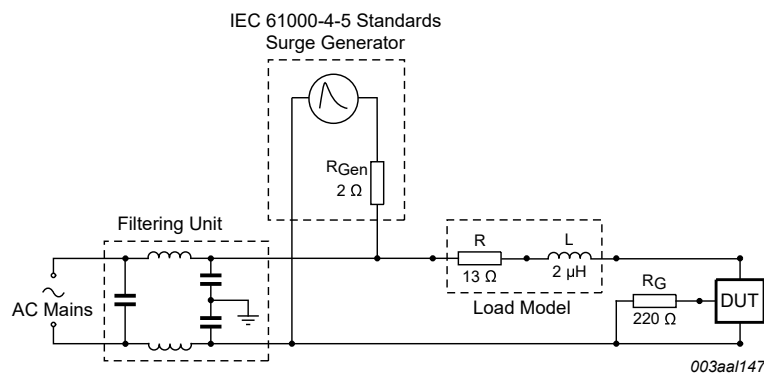


Fig. 6. Test circuit for inductive and resistive loads with conditions equivalent to IEC 61000-4-5

8. Thermal characteristics

Table 5. Thermal characteristics

| Symbol         | Parameter  | Conditions         | Min | Typ | Max | Unit |
|----------------|--|--------------------|-----|-----|-----|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base    | full cycle; Fig. 7 | -   | -   | 2   | K/W  |
| $R_{th(j-a)}$  | thermal resistance from junction to ambient free air | in free air        | -   | 60  | -   | K/W  |

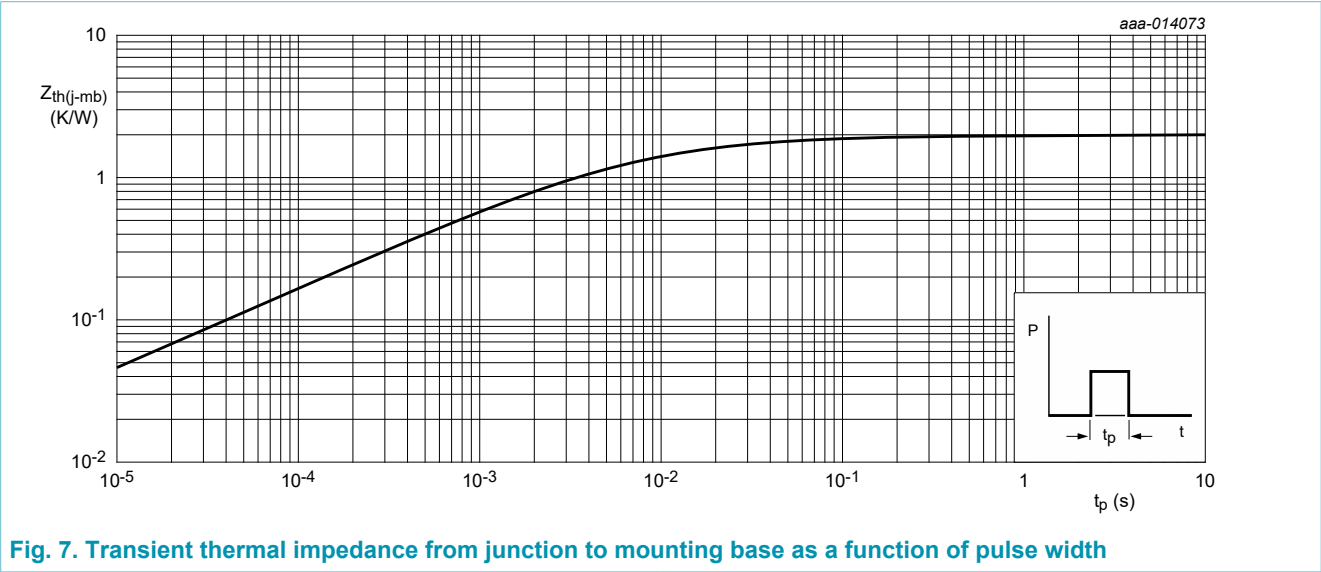


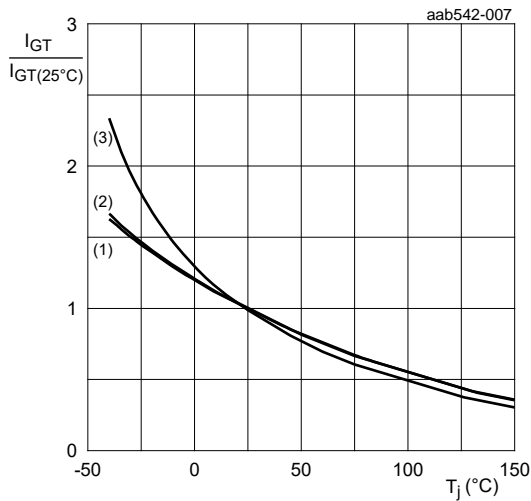
Fig. 7. Transient thermal impedance from junction to mounting base as a function of pulse width

## 9. Characteristics

Table 6. Characteristics

| Symbol                         | Parameter                             | Conditions   | Min  | Typ | Max | Unit             |
|--------------------------------|---------------------------------------|--|------|-----|-----|------------------|
| <b>Static characteristics</b>  |                                       |  |      |     |     |                  |
| $I_{GT}$                       | gate trigger current                  | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; LD+ G+;<br>$T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 8</a>   | 5    | -   | 35  | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; LD+ G-;<br>$T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 8</a>   | 5    | -   | 35  | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; LD- G-;<br>$T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 8</a>   | 5    | -   | 35  | mA               |
| $I_L$                          | latching current                      | $V_D = 12\text{ V}$ ; $I_G = 100\text{ mA}$ ; LD+ G+;<br>$T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 9</a>   | -    | -   | 40  | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_G = 100\text{ mA}$ ; LD+ G-;<br>$T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 9</a>   | -    | -   | 50  | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_G = 100\text{ mA}$ ; LD- G-;<br>$T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 9</a>   | -    | -   | 40  | mA               |
| $I_H$                          | holding current                       | $V_D = 12\text{ V}$ ; $T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 10</a>   | -    | -   | 30  | mA               |
| $V_T$                          | on-state voltage                      | $I_T = 14\text{ A}$ ; $T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 11</a>   | -    | -   | 1.5 | V                |
| $V_{GT}$                       | gate trigger voltage                  | $V_D = 12\text{ V}$ ; $I_T = 100\text{ mA}$ ; $T_j = 25\text{ }^\circ\text{C}$ ;<br><a href="#">Fig. 12</a>  | -    | 0.8 | 1   | V                |
|                                |                                       | $V_D = 400\text{ V}$ ; $I_T = 100\text{ mA}$ ; $T_j = 150\text{ }^\circ\text{C}$ ;<br><a href="#">Fig. 12</a>  | 0.2  | 0.5 | -   | V                |
| $I_D$                          | off-state current                     | $V_D = 800\text{ V}$ ; $T_j = 25\text{ }^\circ\text{C}$  | -    | -   | 10  | $\mu\text{A}$    |
|                                |                                       | $V_D = 800\text{ V}$ ; $T_j = 150\text{ }^\circ\text{C}$   | -    | -   | 2   | mA               |
| $V_{CL}$                       | clamping voltage                      | $I_{CL} = 0.1\text{ mA}$ ; $t_p = 1\text{ ms}$ ; $T_j = 25\text{ }^\circ\text{C}$  | 850  | -   | -   | V                |
| <b>Dynamic characteristics</b> |                                       |  |      |     |     |                  |
| $dV_D/dt$                      | rate of rise of off-state voltage     | $V_{DM} = 536\text{ V}$ ; $T_j = 125\text{ }^\circ\text{C}$ ; ( $V_{DM} = 67\%$ of $V_{DRM}$ ); exponential waveform; gate open circuit                                    | 4000 | -   | -   | V/ $\mu\text{s}$ |
|                                |                                       | $V_{DM} = 536\text{ V}$ ; $T_j = 150\text{ }^\circ\text{C}$ ; exponential waveform; gate open circuit  | 2000 | -   | -   | V/ $\mu\text{s}$ |
| $dI_{com}/dt$                  | rate of change of commutating current | $V_D = 400\text{ V}$ ; $T_j = 150\text{ }^\circ\text{C}$ ; $I_{T(RMS)} = 10\text{ A}$ ; $dV_{com}/dt = 20\text{ V}/\mu\text{s}$ ; gate open circuit; snubberless condition | 5    | -   | -   | A/ms             |
|                                |                                       | $V_D = 400\text{ V}$ ; $T_j = 150\text{ }^\circ\text{C}$ ; $I_{T(RMS)} = 10\text{ A}$ ; $dV_{com}/dt = 10\text{ V}/\mu\text{s}$ ; gate open circuit                        | 10   | -   | -   | A/ms             |
|                                |                                       | $V_D = 400\text{ V}$ ; $T_j = 150\text{ }^\circ\text{C}$ ; $I_{T(RMS)} = 10\text{ A}$ ; $dV_{com}/dt = 1\text{ V}/\mu\text{s}$ ; gate open circuit                         | 15   | -   | -   | A/ms             |





- (1) LD+ G+
- (2) LD+ G-
- (3) LD- G-

Fig. 8. Normalized gate trigger current as a function of junction temperature

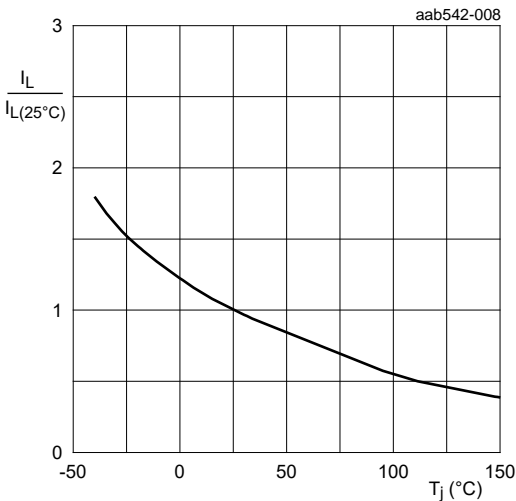


Fig. 9. Normalized latching current as a function of junction temperature

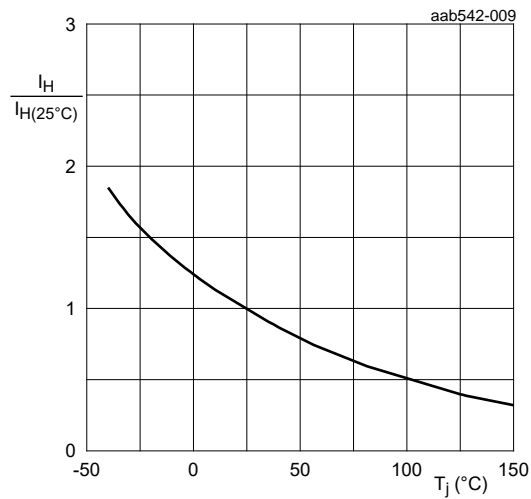
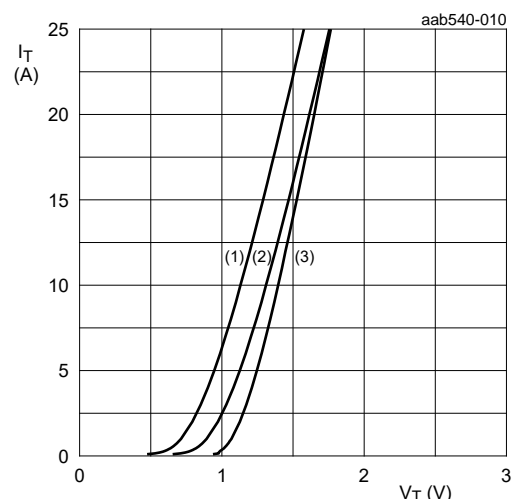


Fig. 10. Normalized holding current as a function of junction temperature



- $V_o = 0.984 \text{ V}$ ;  $R_s = 0.033 \Omega$
- (1)  $T_j = 150^{\circ}\text{C}$ ; typical values
  - (2)  $T_j = 150^{\circ}\text{C}$ ; maximum values
  - (3)  $T_j = 25^{\circ}\text{C}$ ; maximum values

Fig. 11. On-state current as a function of on-state voltage

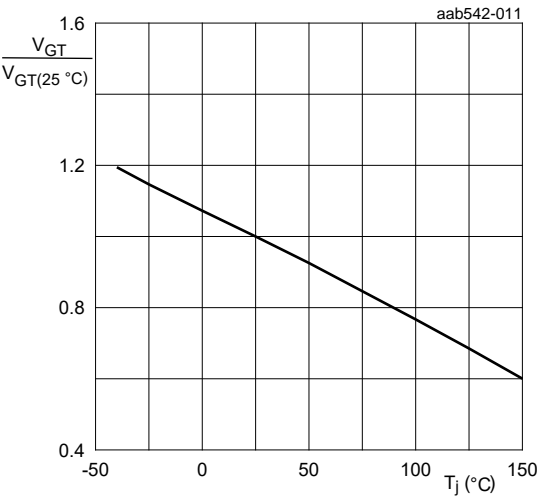


Fig. 12. Normalized gate trigger voltage as a function of junction temperature

10. Package outline

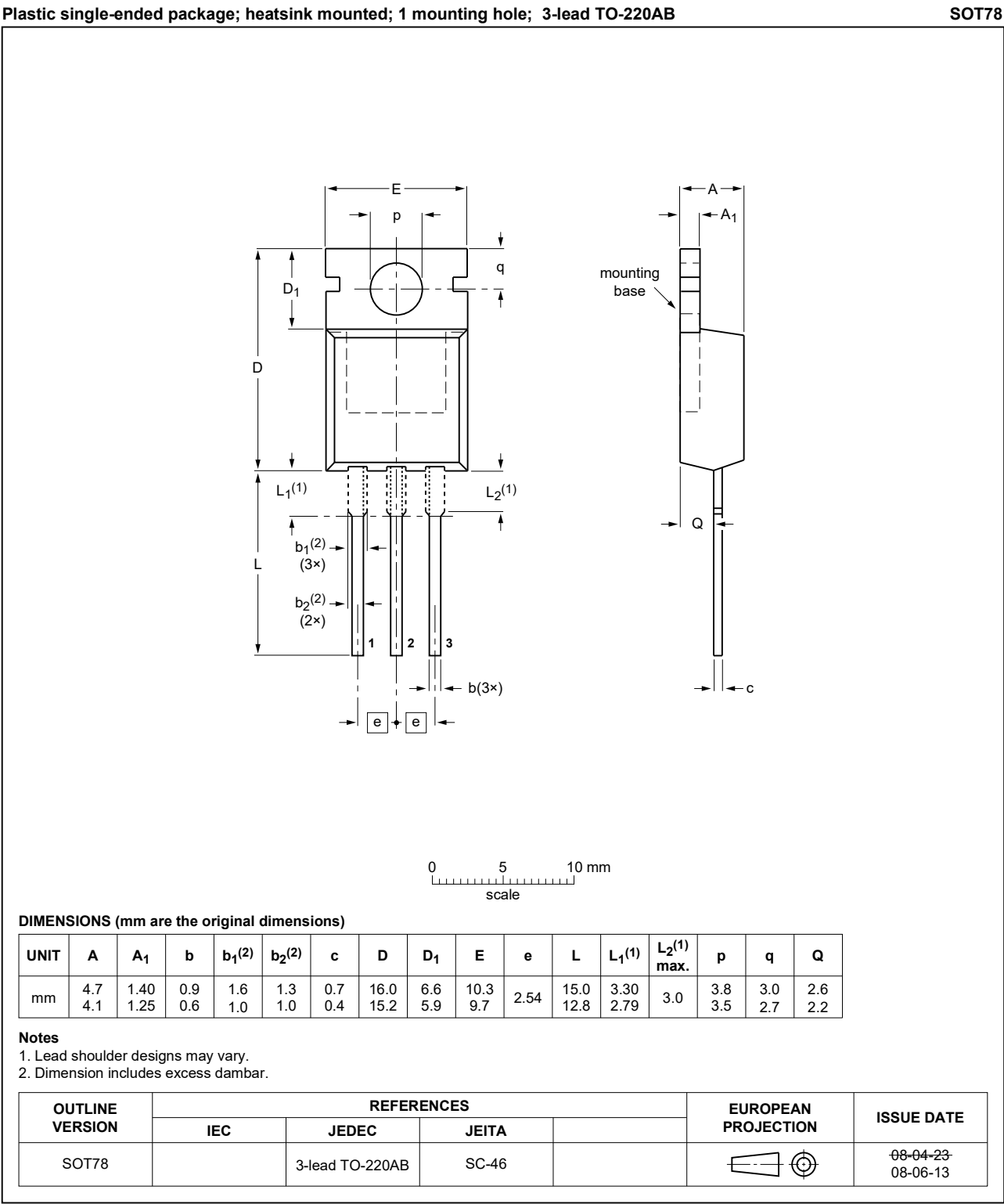


Fig. 13. Package outline TO-220AB (SOT78)

## 11. Legal information

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| Document status [1][2]         | Product status [3] | Definition  |
|--------------------------------|--------------------|---|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
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For sales office addresses, please send an email to: [salesaddresses@ween-semi.com](mailto:salesaddresses@ween-semi.com)

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Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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